

STC12IE90HV

Emitter Switched Bipolar Transistor ESBT[®] 900 V - 12 A - 0.083 Ω

Preliminary Data

General features

V _{CS(ON)}	Ι _C	R _{CS(ON)}
1V	12A	0.083 Ω

- High voltage / high current Cascode configuration
- Low equivalent on resistance
- Very fast-switch up to 150 kHz
- Squared RBSOA up to 900V
- Very low C_{iss} driven by $R_G = 47\Omega$
- Very low turn-off cross over time

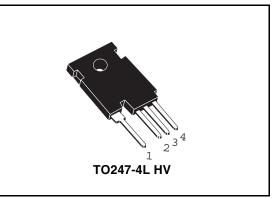
Applications

■ Aux Smps For Three Phase Mains

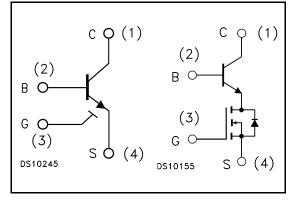
Description

The STC12IE90HV is manufactured in Monolithic ESBT Technology, aimed to provide best performances in high frequency / high voltage applications.

It is designed for use in Gate Driven based topologies.



Internal schematic diagrams



Order codes

Part Number	Marking	Package	Packaging
STC12IE90HV	C12IE90HV	TO247-4L HV	Tube

January 2007

This is preliminary information on a new product now in development or undergoing evaluation. Details are subject to change without notice.

Contents

1	Electrical ratings
2	Electrical characteristics 4
	2.1 Electrical characteristics (curves) 5
	2.2 Test circuits
3	Package mechanical data8
4	Revision history



1 Electrical ratings

Table 1.	Absolute maximum rating			
Symbol	Parameter	Value	Unit	
V _{CS(SS)}	Collector-source voltage ($V_{BS} = V_{GS} = 0 V$)	900	V	
V _{BS(OS)}	Base-source voltage ($I_C = 0$, $V_{GS} = 0$ V)	30	V	
V _{SB(OS)}	Source-base voltage ($I_C = 0$, $V_{GS} = 0$ V)	17	V	
V _{GS}	Gate-source voltage	± 17	V	
۱ _C	Collector current	12	А	
I _{CM}	Collector peak current (t _P < 5ms)	36	Α	
۱ _B	Base current	6	А	
I _{BM}	Base peak current (t _P < 5ms)	10	А	
P _{tot}	Total dissipation at $T_c = 25^{\circ}C$	208	W	
T _{stg}	Storage temperature	-40 to 150	°C	
Т _Ј	Max. operating junction temperature	150	°C	

Table 1. Absolute maximum rating

Table 2. Thermal data

Symbol	Parameter	Value	Unit
R _{thj-case}	Thermal resistance junction-case max	0.6	°C/W



2 Electrical characteristics

($T_{case} = 25^{\circ}C$ unless otherwise specified)

able 5. Electrical characteristics						
Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
I _{CS(SS)}	Collector-source current $(V_{BS} = V_{GS} = 0)$	V _{CE} = 900V			100	μA
I _{BS(OS)}	Base-source current $(I_{C} = 0, V_{GS} = 0)$	V _{BS(OS)} = 30V			10	μA
I _{SB(OS)}	Source-base current $(I_{C} = 0, V_{GS} = 0)$	V _{SB(OS)} = 17V			100	μA
IGS(OS)	Gate-source leakage	$V_{GS} = \pm 17V$			100	nA
V _{CS(ON)}	Collector-source ON voltage	$V_{GS} = 10V$ $I_C = 12A$ $I_B = 2.4A$ $V_{GS} = 10V$ $I_C = 6A$ $I_B = 0.6A$		1 0.6		V V
h _{FE}	DC current gain			5 15		
V _{BS(ON)}	Base Source ON voltage	$V_{GS} = 10V I_C = 12A I_B = 2.4A$ $V_{GS} = 10V I_C = 6A I_B = 0.6A$		1.5 1.2		V V
V _{GS(th)}	Gate threshold voltage	$V_{BS} = V_{GS}$ $I_B = 250 \mu A$	2	3	4	V
C _{iss}	Input capacitance	V _{CS} =25V f =1MHz V _{GS} =0V		520		pF
Q _{GS(tot)}	Gate-source Charge	$V_{CS}=25V$ $V_{GS}=10V$ $V_{CB}=0V$ $I_{C}=4A$		21.3		nC
t _s t _f	INDUCTIVE LOAD Storage time Fall time	$\label{eq:VGS} \begin{array}{ll} V_{GS} = 10V & R_{G} = 47\Omega \\ V_{Clamp} = 720V & t_{p} = 4\mu s \\ I_{C} = 6A & I_{B} = 1.2A \end{array}$		610 10		ns ns
t _s t _f	INDUCTIVE LOAD Storage time Fall time	$V_{GS} = 10V$ $R_G = 47\Omega$ $V_{Clamp} = 720V$ $t_p = 4\mu s$ $I_C = 6A$ $I_B = 0.6A$		360 10		ns ns
V _{CSW}	Maximum collector- source voltage switched without snubber	$R_{G} = 47\Omega$ $h_{FE} = 5$ $I_{C} = 12A$	900			V

Table 3. Electrical characteristics

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
V _{CS(dyn)}	Collector-source dynamic voltage (500ns)	$\begin{split} & V_{CC} = V_{Clamp} = \!$		3.37		V
V _{CS(dyn)}	Collector-source dynamic voltage (1µs)	$\begin{split} & V_{CC} = V_{Clamp} = \!$		1.75		v

Table 3. Electrical characteristics

2.1 Electrical characteristics (curves)

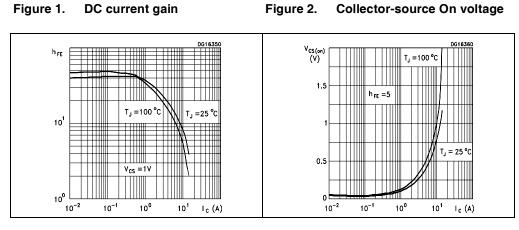


Figure 3. Collector-source On voltage Figure 4. Base-source On voltage

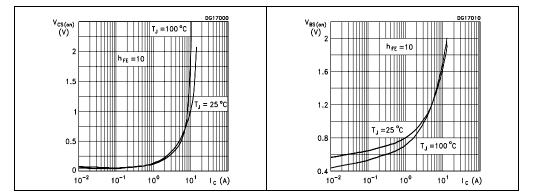


Figure 5.

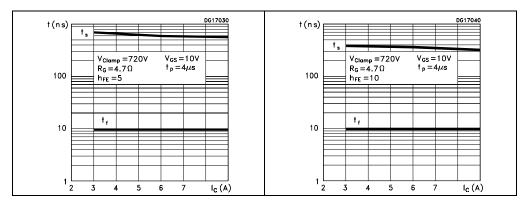
Reverse biased SOA

Dynamic collector-emitter

voltage DG15710 DG17020 V_{CE(sat)dyn} $I_{c}(A)$ $h_{FE} = 5$ $V_{CC} = V_{Clamp} = 400V$ 6 $V_{GS} = 10V$ 12 5 $R_G = 4.7 \Omega$ $|_{Bpeack} = |_{C}$ 4 8 3 I_C=9A 2 I_c=6A $I_c = 3A$ 1 Т 0 200 400 600 800 $V_{CS} = V_{Clamp}(V)$ 0 4 8 12 16 t(μs)

Figure 6.





6/11



2.2 Test circuits

Figure 9. Static V_{CS(ON)} test circuits

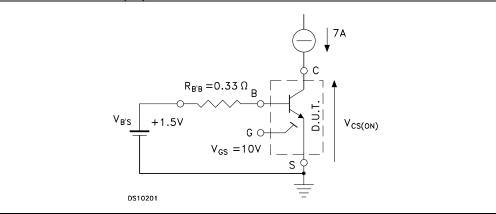
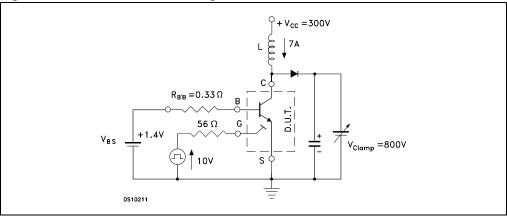


Figure 10. Inductive load switching and RBSOA test circuit





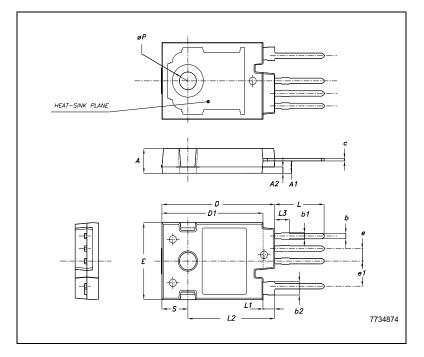
3 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com



DIM.		mm.	
	MIN.	TYP	MAX.
A	4.85		5.15
A1	2.20	2.50	2.60
A2		1.27	
b	0.95	1.10	1.30
b2	2.50		2.90
С	0.40		0.80
D	23.85	24	24.15
D1		21.50	
E	15.45	15.60	15.75
е	2.54		
e1	5.08		
L	10.20		10.80
L1	2.20	2.50	2.80
L2		18.50	
L3		3	
øP	3.55		3.65
S		5.50	

TO247-4L HV MECHANICAL DATA



57

4 Revision history

Table 4. Revision history

Date	Revision	Changes
16-Jan-2007	1	Initial release.



Please Read Carefully:

Information in this document is provided solely in connection with ST products. STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, modifications or improvements, to this document, and the products and services described herein at any time, without notice.

All ST products are sold pursuant to ST's terms and conditions of sale.

Purchasers are solely responsible for the choice, selection and use of the ST products and services described herein, and ST assumes no liability whatsoever relating to the choice, selection or use of the ST products and services described herein.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted under this document. If any part of this document refers to any third party products or services it shall not be deemed a license grant by ST for the use of such third party products or services, or any intellectual property contained therein or considered as a warranty covering the use in any manner whatsoever of such third party products or services or services or services or services or any intellectual property contained therein.

UNLESS OTHERWISE SET FORTH IN ST'S TERMS AND CONDITIONS OF SALE ST DISCLAIMS ANY EXPRESS OR IMPLIED WARRANTY WITH RESPECT TO THE USE AND/OR SALE OF ST PRODUCTS INCLUDING WITHOUT LIMITATION IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION), OR INFRINGEMENT OF ANY PATENT, COPYRIGHT OR OTHER INTELLECTUAL PROPERTY RIGHT.

UNLESS EXPRESSLY APPROVED IN WRITING BY AN AUTHORIZE REPRESENTATIVE OF ST, ST PRODUCTS ARE NOT RECOMMENDED, AUTHORIZED OR WARRANTED FOR USE IN MILITARY, AIR CRAFT, SPACE, LIFE SAVING, OR LIFE SUSTAINING APPLICATIONS, NOR IN PRODUCTS OR SYSTEMS, WHERE FAILURE OR MALFUNCTION MAY RESULT IN PERSONAL INJURY, DEATH, OR SEVERE PROPERTY OR ENVIRONMENTAL DAMAGE. ST PRODUCTS WHICH ARE NOT SPECIFIED AS "AUTOMOTIVE GRADE" MAY ONLY BE USED IN AUTOMOTIVE APPLICATIONS AT USER'S OWN RISK.

Resale of ST products with provisions different from the statements and/or technical features set forth in this document shall immediately void any warranty granted by ST for the ST product or service described herein and shall not create or extend in any manner whatsoever, any liability of ST.

ST and the ST logo are trademarks or registered trademarks of ST in various countries.

Information in this document supersedes and replaces all information previously supplied.

The ST logo is a registered trademark of STMicroelectronics. All other names are the property of their respective owners.

© 2007 STMicroelectronics - All rights reserved

STMicroelectronics group of companies

Australia - Belgium - Brazil - Canada - China - Czech Republic - Finland - France - Germany - Hong Kong - India - Israel - Italy - Japan -Malaysia - Malta - Morocco - Singapore - Spain - Sweden - Switzerland - United Kingdom - United States of America

www.st.com



11/11